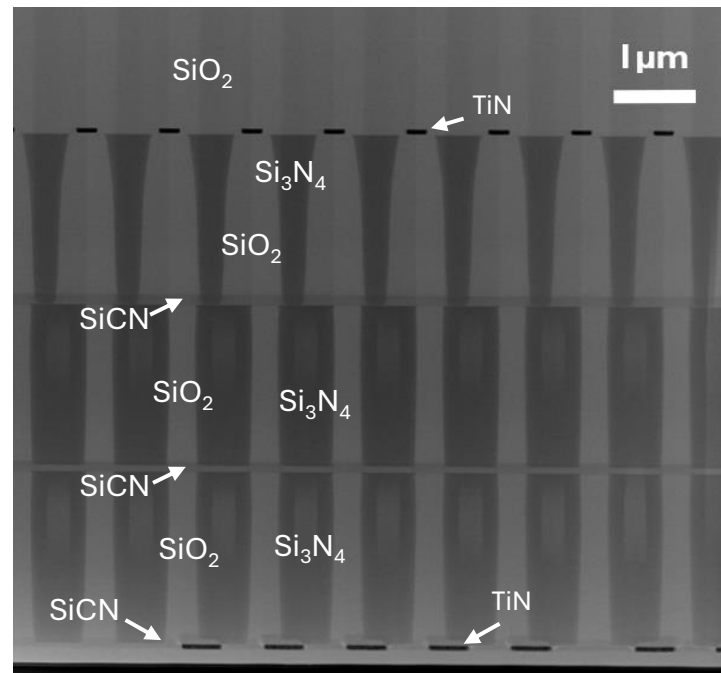
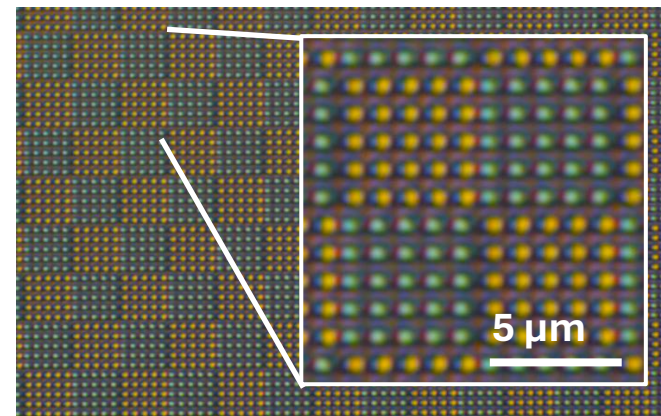
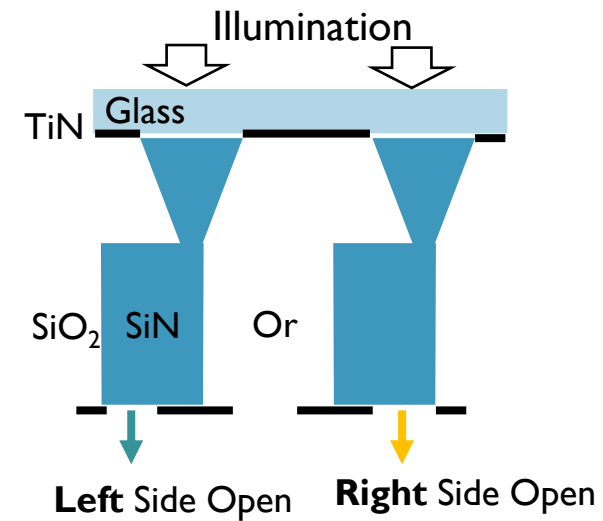


The diagram illustrates a cross-section of a glass substrate with various layers and openings. The layers from top to bottom are: Glass, SiO₂ (1.5 μm), TiN, SiCN (150nm), SiN (2 μm), SiCN, SiN (2 μm), SiCN, SiN (2 μm), SiCN, and Si Oxide (200 nm). Two openings are shown: 'Right Open' and 'Left Open'. The SiN layer is 2 μm thick, and the SiCN layer is 150nm thick. The Si Oxide layer is 200 nm thick.

(b)



(c)



(d)